



Product Description

- The 0805 SMD LED is much smaller, thus enable smaller board size, higher packing density, reduced storage space and finally smaller equipment to be obtained.
- These LEDs have high reliability performance and are designed to work under a wide range of environmental conditions.
- Besides, lightweight makes them ideal for miniature applications. etc.

Features

- · Size(mm): 2.0*1.25*0.85mm
- · Compatible with automatic placement equipment
- · Moisture Sensitivity Level: 3
- · Color type: Green
- · Viewing Angle:120°
- · Pb-free
- · RoHS and REACH compliant

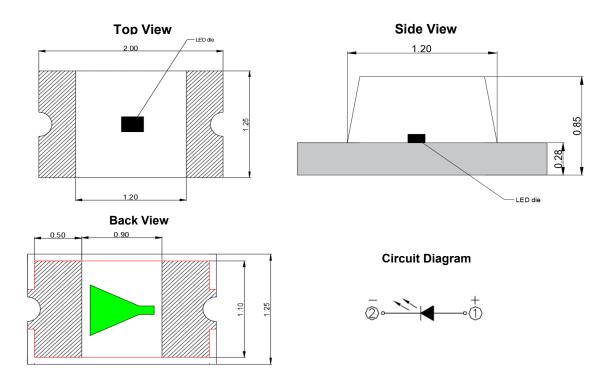
Applications

- Backlighting in dashboard and switch.
- · Digital display for household appliace
- Telecommunication: indicator and backlighting in telephone and fax.
- · Flat backlight for LCD
- · General use



MECHANICAL DIMENSIONS

All dimensions are in mm.



Remark

The tolerance of all dimensions above is 0.1mm.



ABSOLUTE MAXIMUM RATINGS $(T_A = 25^{\circ}C)$

Items	Symbol	Absolute Maxium Rating	Unit
Forward current	I _F	20	mA
Peak Forward Crurrent	I _{FP}	60	mA
Reverse voltage	V_{R}	5	V
Power dissipation	P_{D}	100	mW
Operating temperature	T_{opr}	-40 ~+85	$^{\circ}$
Storage temperature	T_{stg}	-40~+100	$^{\circ}$

Remark: 1/10 Duty cycle, 0.1ms pulse width.

TYPICAL ELECTRICAL & OPTICAL CHARACTERISTICS ($T_A = 25$ °C)

Charateristics	Symbol	Condition	Unit	Minimum	Typical
Forward Volatge	V _F	I _F =5mA	V		2.8
Reverse Current	V_R	V _R =5V	uA		<1
Viewing Angle	2θ _{1/2}	I _F =5mA			120
Luminous intensity	I _V	I _F =5mA	mcd	175	
Spectral Line Half-Width	Δλ	I _F =5mA	nm		15
Dominant Wavelength	λd	I _F =5mA	nm	516	
Peak Wavelength	λр	I _F =5mA	nm		525

^{*} Continuous reverse voltage can cause LED damage.



INTENSITY BIN LIMIT

Green (5mA)			
Bin code	Min.(mcd)	Max.(mcd)	
GM1	175	210	
GM2	210	250	
GM3	250	300	
GM4	300	360	
GM5	360	430	

^{*}Tolerance of measurement of luminous intensity is ±10%.

VOLTAGE BIN LIMIT

Green (5mA)			
Bin code	Min.(V)	Max.(V)	
GV1	2.4	2.5	
GV2	2.5	2.6	
GV3	2.6	2.7	
GV4	2.7	2.8	
GV5	2.8	2.9	
GV6	2.9	3.0	
GV7	3	3.1	

^{*}Tolerance of measurement of voltage is ± 0.05 V.

Color BIN LIMIT

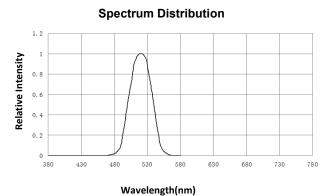
Green (5mA)			
Bin code	Min.(nm)	Max.(nm)	
GD1	516	519	
GD2	519	522	
GD3	522	525	
GD4	525	528	
GD5	528	531	
RD6	531	534	

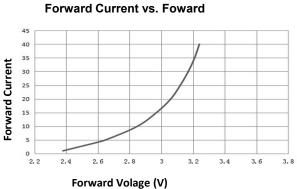
^{*}Tolerance of measurement of wavelength is ±1nm

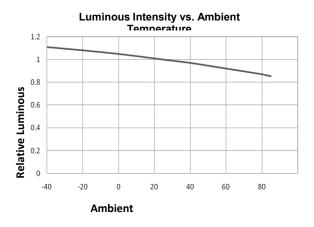


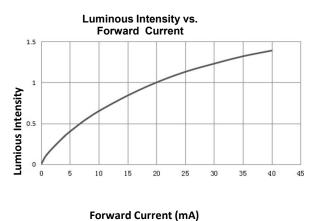
TYPICAL ELECTRO-OPTICAL CHARATERISTICS CURES(Ta=25°C)

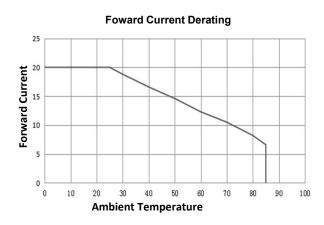
The data below are collected from statistical figures that do not necessarily correspond to the actual parameters of each single LED. Hence, these data will be changed without further notice.

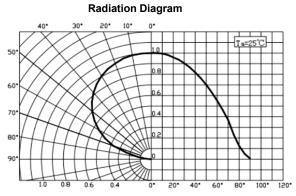








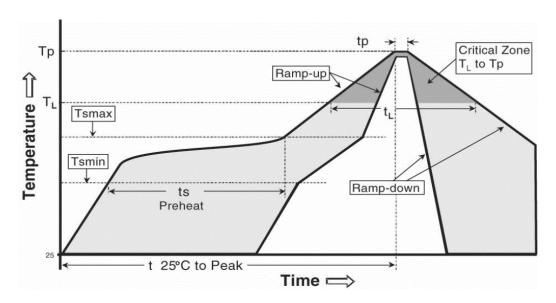






REFLOW SOLDERING

- The CHIP LED is rated as a MSL3 as general request product.
- The recommended floor life out of bag is 24hrs.
- The temperature profile is as below.



IPC/JEDEC J-STD-020C

Profile Feature	Pb-Free Assembly
Average ramp-up rate(Tsmax to Tp)	3°C/second max.
Preheat	
- Temperature Min(Ts _{min})	150℃
- Temperature Max(Ts _{max})	200℃
- Time(Tsmin to Ts _{max})	60-180 seconds
Time mainted above	
- Temperature(T _L)	217℃
- Time(T _L)	60-150 seconds
Peak Temperature(Tp)	260℃
Time within 5°C of actual peak Temperature(tp) ²	20-40 seconds
Ramp-down Rate	6°C/second max.
Time 25°C to peak Temperature	8 minutes max.



Moisture Sensitivity

- · Beking recommends keeping CHIP LEDs in the provided, resealable moisture-barrier packaging (MBP) until immediately prior to soldering. Unopened MBPs that contain CHIP LEDs do not need special storage for moisture sensitivity.
- \cdot Once the MBP is opened, CHIP LEDs may be stored as MSL 3 per IPC/JEDEC J-STD-020C, meaning they have one year of floor life in conditions of ≤ 30 °C/60% relative humidity (RH). Regardless of the storage condition, Beking LED recommends sealing any unsoldered CHIP LEDs in the original MBP.

Handling

- ·The packaging sizes of these SMD products are very small. Users are required to handle with care.
- ·To avoid damaging the product's surface and interior device, it is recommended to choose a

Repairing

Repair should not be recommended after SMT production. When repairing is needed, a double-head soldering iron should be used (as below figure). It should be assured before handing whether the electrical and optical characteristics of the LEDs will or will not be damaged by



Fig.1 Pickig up a LED using an tweezer with care

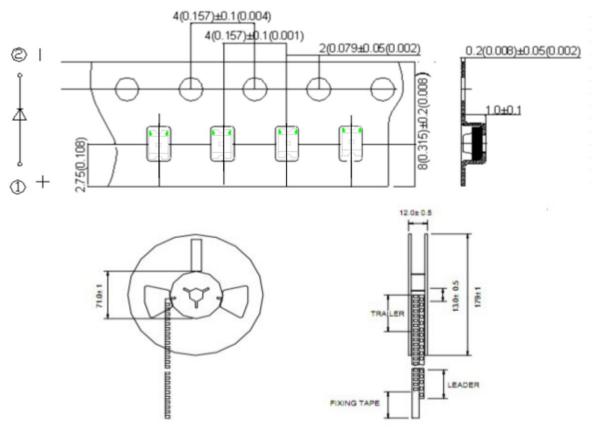


Fig2. Repairing using a doublehead soldering iron



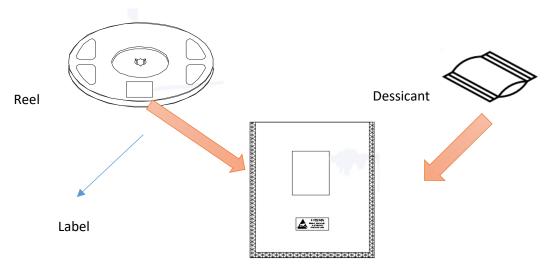
PACKING

Carrier Tape Dimensions: Loaded quantity 3000pcs per reel.



All dimensions are in millimeters.

Tolerance of measurement of all dimensions is $\pm 0.1 \text{mm}$



Polyethylene Bag